

# International **IR** Rectifier

**REPETITIVE AVALANCHE AND dv/dt RATED  
HEXFET® TRANSISTORS  
THRU-HOLE (TO-204AA/AE)**

**IRF250  
JANTX2N6766  
JANTXV2N6766  
[REF:MIL-PRF-19500/543]  
200V, N-CHANNEL**

## Product Summary

Part Number	BVDSS	RDS(on)	ID
IRF250	200V	0.085Ω	30A

The HEXFET® technology is the key to International Rectifier's advanced line of power MOSFET transistors. The efficient geometry and unique processing of this latest "State of the Art" design achieves: very low on-state resistance combined with high transconductance; superior reverse energy and diode recovery dv/dt capability.

The HEXFET transistors also feature all of the well established advantages of MOSFETs such as voltage control, very fast switching, ease of paralleling and temperature stability of the electrical parameters.

They are well suited for applications such as switching power supplies, motor controls, inverters, choppers, audio amplifiers and high energy pulse circuits.



**TO-3**

## Features:

- Repetitive Avalanche Ratings
- Dynamic dv/dt Rating
- Hermetically Sealed
- Simple Drive Requirements
- Ease of Paralleling

## Absolute Maximum Ratings

	Parameter	Units	
ID @ VGS = 10V, TC = 25°C	Continuous Drain Current	A	30
ID @ VGS = 10V, TC = 100°C	Continuous Drain Current		19
IDM	Pulsed Drain Current ①		120
PD @ TC = 25°C	Max. Power Dissipation	W	150
	Linear Derating Factor	W/°C	1.2
VGS	Gate-to-Source Voltage	V	±20
EAS	Single Pulse Avalanche Energy ②	mJ	500
IAR	Avalanche Current ①	A	30
EAR	Repetitive Avalanche Energy ①	mJ	15
dv/dt	Peak Diode Recovery dv/dt ③	V/ns	5.0
TJ	Operating Junction	°C	-55 to 150
TSTG	Storage Temperature Range		
	Lead Temperature		300 (0.063 in. (1.6mm) from case for 10s)
	Weight	g	11.5 (typical)

For footnotes refer to the last page

**Electrical Characteristics @  $T_j = 25^\circ\text{C}$  (Unless Otherwise Specified)**

Parameter		Min	Typ	Max	Units	Test Conditions
BV <sub>DSS</sub>	Drain-to-Source Breakdown Voltage	200	—	—	V	$V_{GS} = 0\text{V}, I_D = 1.0\text{mA}$
$\Delta BV_{DSS}/\Delta T_J$	Temperature Coefficient of Breakdown Voltage	—	0.29	—	V/ $^\circ\text{C}$	Reference to $25^\circ\text{C}, I_D = 1.0\text{mA}$
$R_{DS(on)}$	Static Drain-to-Source On-State Resistance	—	—	0.085	$\Omega$	$V_{GS} = 10\text{V}, I_D = 19\text{A}$ ④
		—	—	0.090		$V_{GS} = 10\text{V}, I_D = 30\text{A}$ ④
$V_{GS(\text{th})}$	Gate Threshold Voltage	2.0	—	4.0	V	$V_{DS} = V_{GS}, I_D = 250\mu\text{A}$
$g_{fs}$	Forward Transconductance	9.0	—	—	S ( $\text{mS}$ )	$V_{DS} > 15\text{V}, I_{DS} = 19\text{A}$ ④
$I_{DSS}$	Zero Gate Voltage Drain Current	—	—	25	$\mu\text{A}$	$V_{DS} = 160\text{V}, V_{GS} = 0\text{V}$
		—	—	250		$V_{DS} = 160\text{V}$ $V_{GS} = 0\text{V}, T_J = 125^\circ\text{C}$
$I_{GSS}$	Gate-to-Source Leakage Forward	—	—	100	$\text{nA}$	$V_{GS} = 20\text{V}$
$I_{GSS}$	Gate-to-Source Leakage Reverse	—	—	-100		$V_{GS} = -20\text{V}$
$Q_g$	Total Gate Charge	55	—	115	$\text{nC}$	$V_{GS} = 10\text{V}, I_D = 30\text{A}$
$Q_{gs}$	Gate-to-Source Charge	8	—	22		$V_{DS} = 100\text{V}$
$Q_{gd}$	Gate-to-Drain ('Miller') Charge	30	—	60		
$t_{d(on)}$	Turn-On Delay Time	—	—	35	$\text{n s}$	$V_{DD} = 100\text{V}, I_D = 30\text{A}, R_G = 2.35\Omega$
$t_r$	Rise Time	—	—	190		
$t_{d(off)}$	Turn-Off Delay Time	—	—	170		
$t_f$	Fall Time	—	—	130		
$L_{S + LD}$	Total Inductance	—	6.1	—	nH	Measured from the center of drain pad to center of source pad
$C_{iss}$	Input Capacitance	—	3500	—	$\text{pF}$	$V_{GS} = 0\text{V}, V_{DS} = 25\text{V}$ $f = 1.0\text{MHz}$
$C_{oss}$	Output Capacitance	—	700	—		
$C_{rss}$	Reverse Transfer Capacitance	—	110	—		

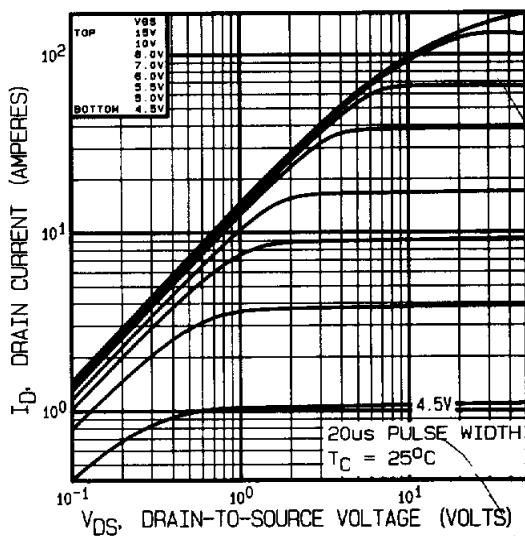
**Source-Drain Diode Ratings and Characteristics**

	Parameter	Min	Typ	Max	Units	Test Conditions
$I_S$	Continuous Source Current (Body Diode)	—	—	30	A	$T_j = 25^\circ\text{C}, I_S = 30\text{A}, V_{GS} = 0\text{V}$ ④
$I_{SM}$	Pulse Source Current (Body Diode) ①	—	—	120		
$V_{SD}$	Diode Forward Voltage	—	—	1.9	V	$T_j = 25^\circ\text{C}, I_S = 30\text{A}, V_{GS} = 0\text{V}$ ④
$t_{rr}$	Reverse Recovery Time	—	—	950	nS	$T_j = 25^\circ\text{C}, I_F = 30\text{A}, dI/dt \leq 100\text{A}/\mu\text{s}$
$Q_{RR}$	Reverse Recovery Charge	—	—	9.0	$\mu\text{C}$	$V_{DD} \leq 50\text{V}$ ④
$t_{on}$	Forward Turn-On Time	Intrinsic turn-on time is negligible. Turn-on speed is substantially controlled by $L_{S + LD}$ .				

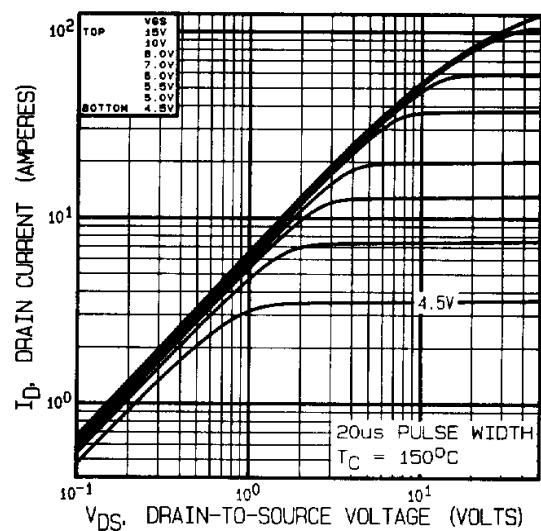
**Thermal Resistance**

	Parameter	Min	Typ	Max	Units	Test Conditions
$R_{thJC}$	Junction to Case	—	—	0.83	$^\circ\text{C/W}$	Typical socket mount
$R_{thJA}$	Junction to Ambient	—	—	30		

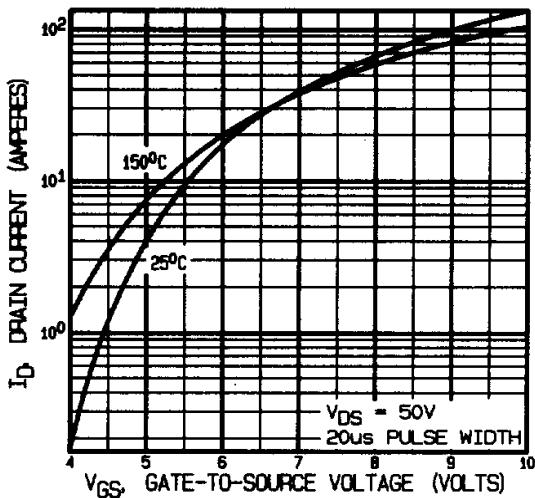
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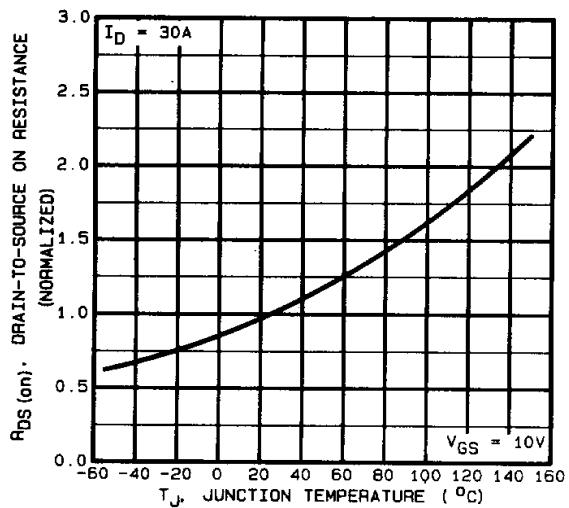
**Fig 1.** Typical Output Characteristics



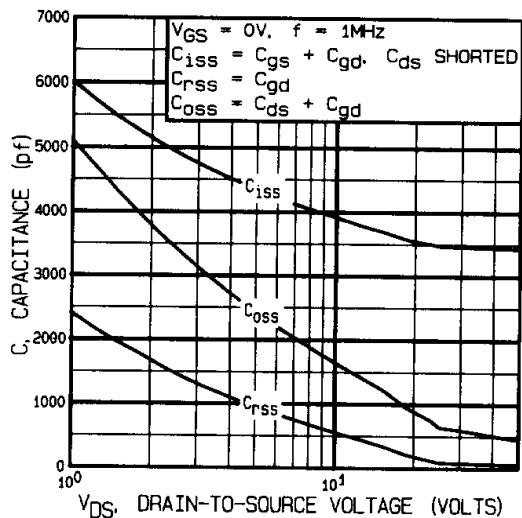
**Fig 2.** Typical Output Characteristics



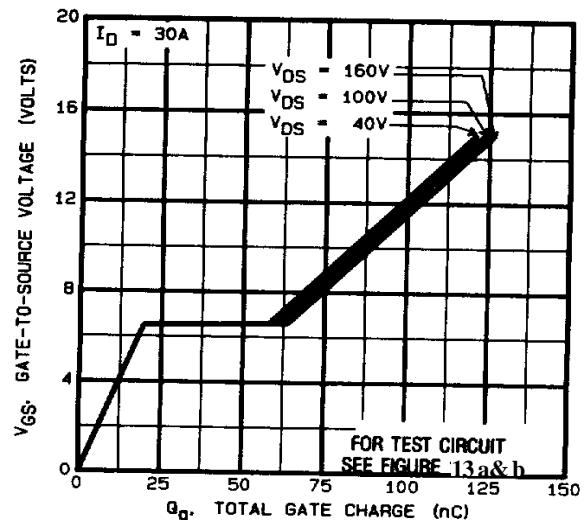
**Fig 3.** Typical Transfer Characteristics



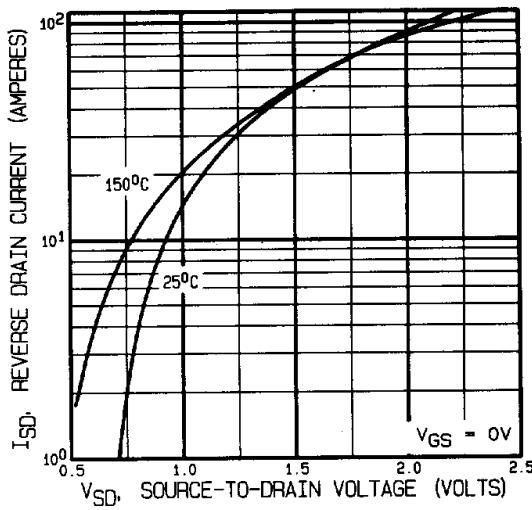
**Fig 4.** Normalized On-Resistance Vs. Temperature



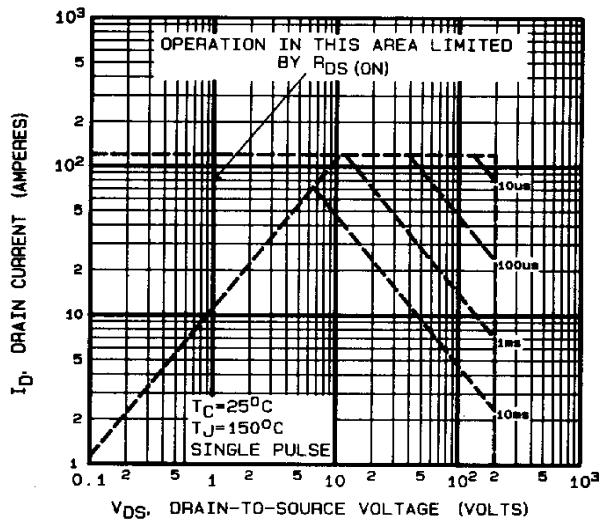
**Fig 5.** Typical Capacitance Vs.  
Drain-to-Source Voltage



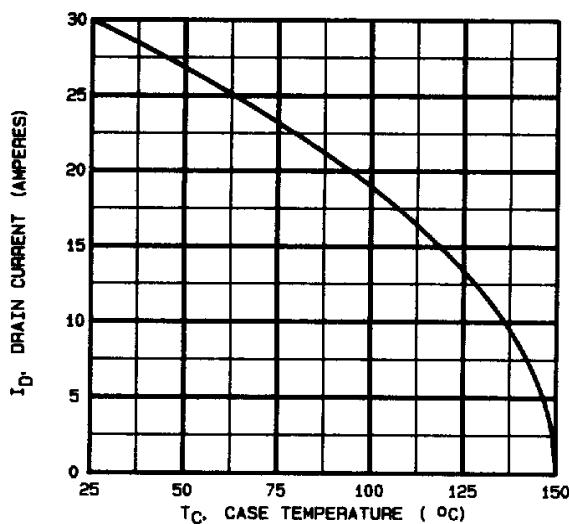
**Fig 6.** Typical Gate Charge Vs.  
Gate-to-Source Voltage



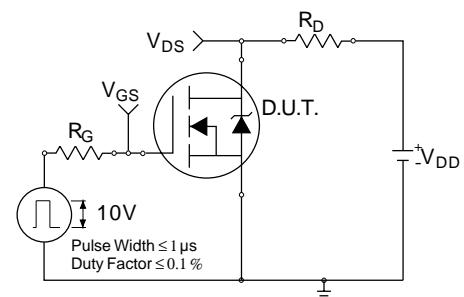
**Fig 7.** Typical Source-Drain Diode  
Forward Voltage



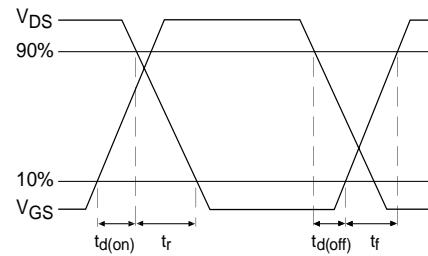
**Fig 8.** Maximum Safe Operating Area



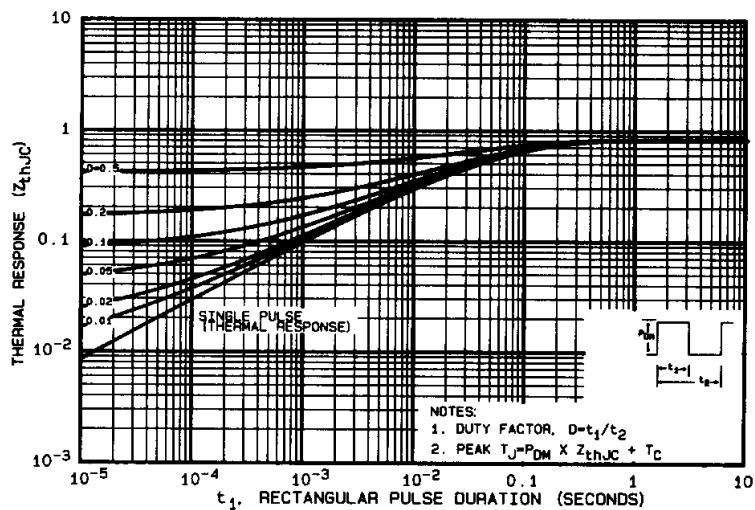
**Fig 9.** Maximum Drain Current Vs.  
Case Temperature



**Fig 10a.** Switching Time Test Circuit



**Fig 10b.** Switching Time Waveforms



**Fig 11.** Maximum Effective Transient Thermal Impedance, Junction-to-Case

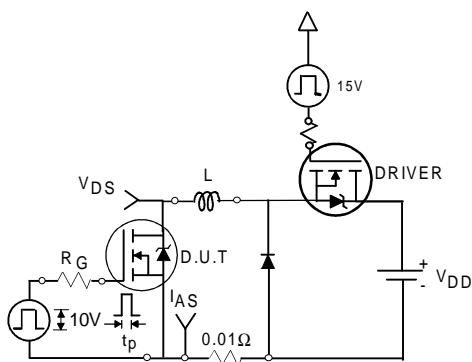


Fig 12a. Unclamped Inductive Test Circuit

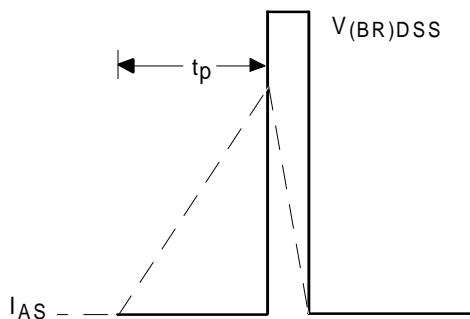


Fig 12b. Unclamped Inductive Waveforms

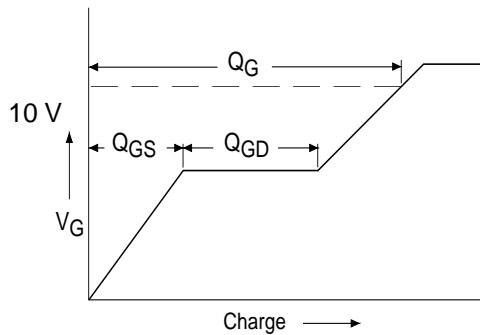


Fig 13a. Basic Gate Charge Waveform

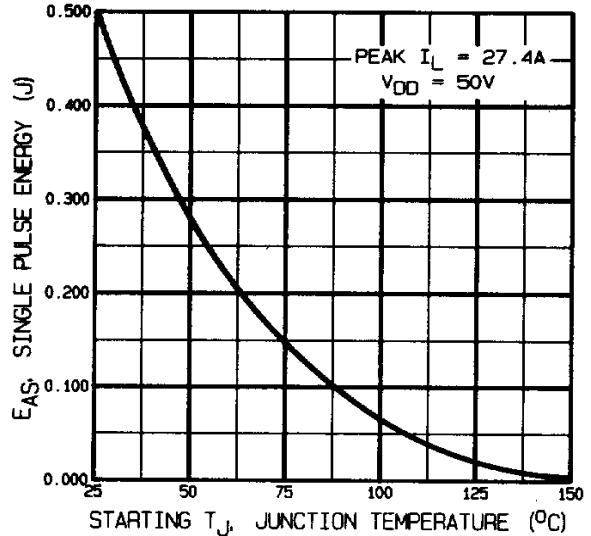


Fig 12c. Maximum Avalanche Energy Vs. Drain Current

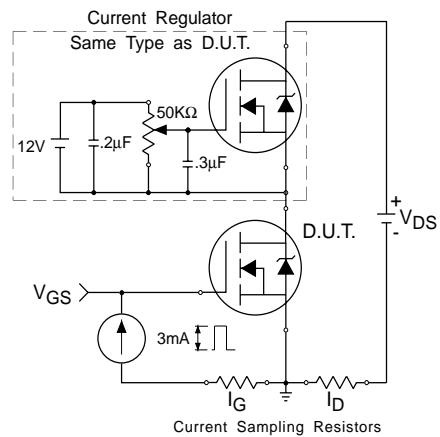
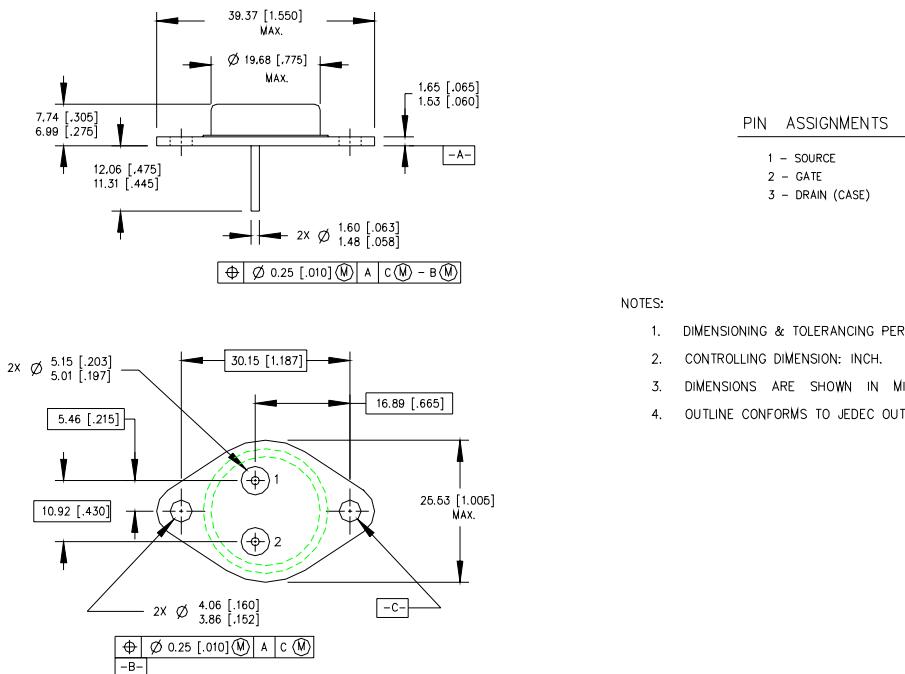


Fig 13b. Gate Charge Test Circuit

## Foot Notes:

- ① Repetitive Rating; Pulse width limited by maximum junction temperature.
- ② V<sub>DD</sub> = 50V, starting T<sub>J</sub> = 25°C,  
Peak I<sub>L</sub> = 30A,
- ③ I<sub>SD</sub> ≤ 30A, di/dt ≤ 190A/μs,  
V<sub>DD</sub> ≤ 200V, T<sub>J</sub> ≤ 150°C  
Suggested RG = 2.35 Ω
- ④ Pulse width ≤ 300 μs; Duty Cycle ≤ 2%

## Case Outline and Dimensions —TO-204AE (Modified TO-3)



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**IR** Rectifier

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